

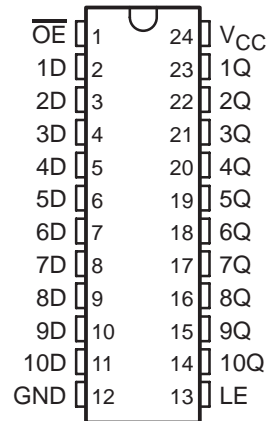
SN74ALS29841

10-BIT BUS-INTERFACE D-TYPE LATCH WITH 3-STATE OUTPUTS

SDAS149A – JUNE 1988 – REVISED JANUARY 1995

- 3-State Buffer-Type Outputs Drive Bus Lines Directly
- Bus-Structured Pinout
- Provides Extra Bus-Driving Latches Necessary for Wider Address/Data Paths or Buses With Parity
- Buffered Control Inputs Reduce dc Loading Effects
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

DW OR NT PACKAGE
(TOP VIEW)



description

This 10-bit latch features 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The ten latches are transparent D-type latches. The SN74ALS29841 has noninverting data (D) inputs.

A buffered output-enable (\overline{OE}) input can place the ten outputs in either a normal logic state (high or low logic levels) or in a high-impedance state. The outputs also are in the high-impedance state during power-up and power-down conditions. The outputs remain in the high-impedance state while the device is powered down. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

\overline{OE} does not affect the internal operation of the latches. Old data can be retained or new data can be entered while the outputs are off.

The SN74ALS29841 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

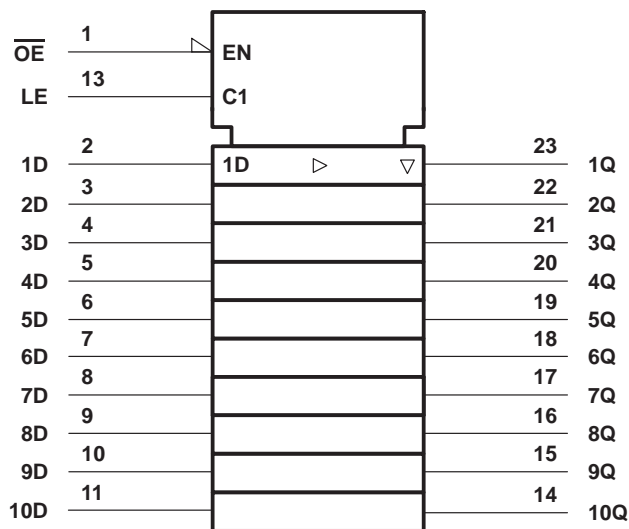
INPUTS			OUTPUT
\overline{OE}	LE	D	Q
L	H	H	H
L	H	L	L
L	L	X	Q ₀
H	X	X	Z

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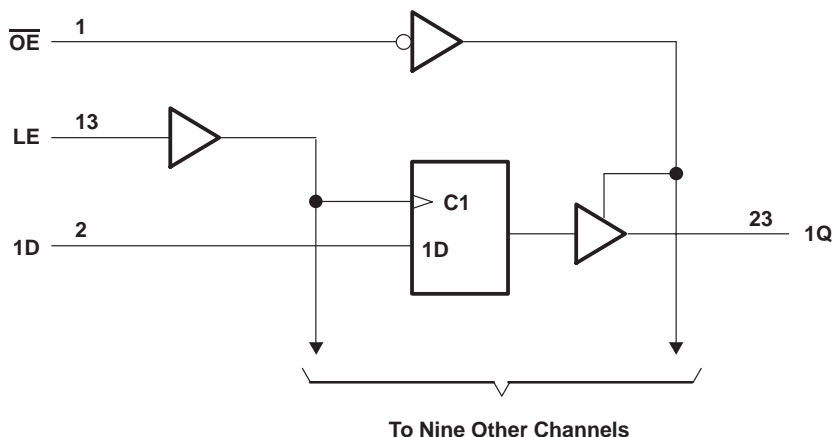
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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SDAS149A – JUNE 1988 – REVISED JANUARY 1995

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
I_{OH}	High-level output current			-24	mA
I_{OL}	Low-level output current			48	mA
t_w	Pulse duration, LE high	6			ns
t_{su}	Setup time, data before LE↓	2.5			ns
t_h	Hold time, data after LE↓	4.5			ns
T_A	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V_{IK}	$V_{CC} = 4.75\text{ V}$, $I_I = -18\text{ mA}$			-1.2	V
V_{OH}	$V_{CC} = 4.75\text{ V}$	$I_{OH} = -15\text{ mA}$	2.4	3.3	V
		$I_{OH} = -24\text{ mA}$	2	3.1	
V_{OL}	$V_{CC} = 4.75\text{ V}$, $I_{OL} = 48\text{ mA}$		0.35	0.5	V
I_{OZH}	$V_{CC} = 5.25\text{ V}$, $V_O = 2.7\text{ V}$			20	μA
I_{OZL}	$V_{CC} = 5.25\text{ V}$, $V_O = 0.4\text{ V}$			-20	μA
I_I	$V_{CC} = 5.25\text{ V}$, $V_I = 5.5\text{ V}$			0.1	mA
I_{IH}	$V_{CC} = 5.25\text{ V}$, $V_I = 2.7\text{ V}$			20	μA
I_{IL}	$V_{CC} = 5.25\text{ V}$, $V_I = 0.4\text{ V}$			-0.2	mA
$I_{OS}‡$	$V_{CC} = 5.25\text{ V}$, $V_O = 0$	-75		-250	mA
I_{CC}	$V_{CC} = 5.25\text{ V}$, Outputs low		55	85	mA

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.



SN74ALS29841

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SDAS149A – JUNE 1988 – REVISED JANUARY 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V _{CC} = MIN to MAX†, T _A = MIN to MAX†		UNIT
				MIN	MAX	
t _{PLH}	D	Any Q	C _L = 50 pF	2	9.5	ns
t _{PHL}				2	9.5	
t _{PLH}	D	Any Q	C _L = 300 pF		14	ns
t _{PHL}					14	
t _{PLH}	LE	Any Q	C _L = 50 pF		12	ns
t _{PHL}					12	
t _{PLH}	LE	Any Q	C _L = 300 pF		16	ns
t _{PHL}					16	
t _{PZH}	\overline{OE}	Any Q	C _L = 50 pF		14	ns
t _{PZL}					14	
t _{PZH}	\overline{OE}	Any Q	C _L = 300 pF		20	ns
t _{PZL}					23	
t _{PHZ}	\overline{OE}	Any Q	C _L = 50 pF		15	ns
t _{PLZ}					12	
t _{PHZ}	\overline{OE}	Any Q	C _L = 5 pF		9	ns
t _{PLZ}					9	

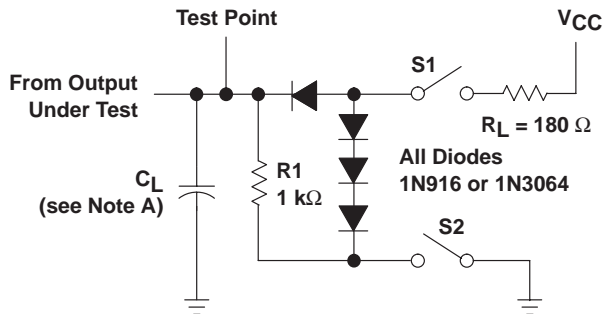
† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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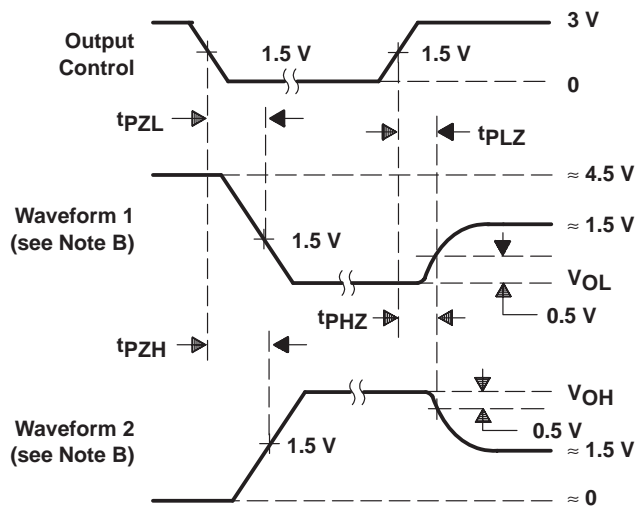
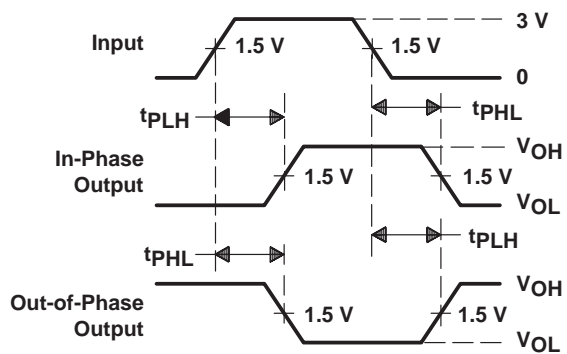
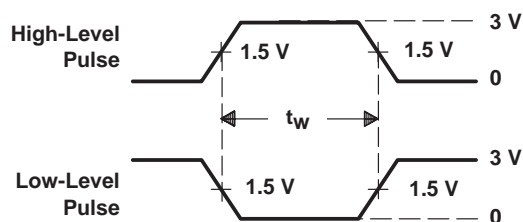
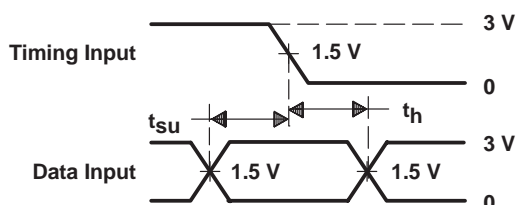
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PARAMETER MEASUREMENT INFORMATION



SWITCH POSITION TABLE

TEST	S1	S2
t _{PLH}	Closed	Closed
t _{PHL}	Closed	Closed
t _{PZH}	Open	Closed
t _{PZL}	Closed	Open
t _{PHZ}	Closed	Closed
t _{PLZ}	Closed	Closed



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN74ALS29841DW	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI	Samples Not Available
SN74ALS29841NT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	Samples Not Available

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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MECHANICAL DATA

NT (R-PDIP-T**) 24 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 -  The 28 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - D. Falls within JEDEC MS-013 variation AD.

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